

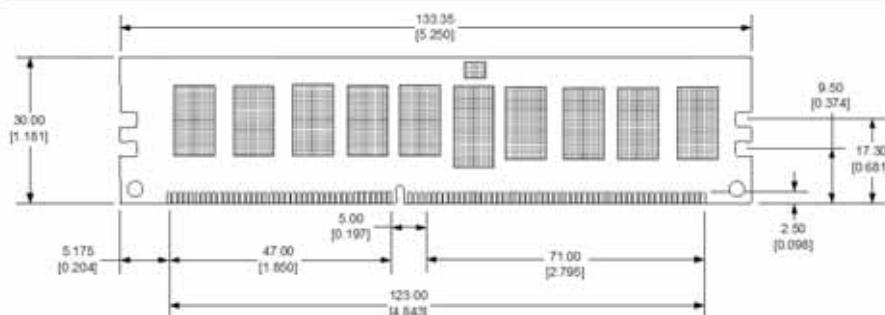
### Products in Family

GRSX6270-10/2GB (1 x 2GB 1Rx4 DIMMs)  
 GRSX6270-810/2GB (1 x 2GB 2Rx8 DIMMs)  
 GRSX6270-10/4GB (1 x 4GB 2Rx4 DIMMs)  
 GRSX6270-10/8GB (1 x 8GB 2Rx4 DIMMs)



Features	Description	
240-pin JEDEC-compliant DIMMs 133.35 mm wide by 30 mm high (1.181" x 5.25") Data Transfer Rate: 10.6 Gigabytes/sec Operating Voltage: 1.5 V ±0.075 Fully RoHS Compliant Thermal Sensor	Each GRSX6270-10 upgrade consists of a single DDR3-1066 Registered ECC DIMM that conforms to JEDEC's DDR3, PC3-8500 standard. One 2K-bit EEPROM is used for Serial Presence Detect and a combination register/PLL with Address and Command Parity is also used. A thermal sensor accurately monitors the DIMM module and can prevent exceeding the maximum operating temperature of 95C.	
Dataram Product	Sun Microsystems Product	Supported in these Sun Microsystems systems:
GRSX6270-10/2GB GRSX6270-810/2GB GRSX6270-10/4GB GRSX6270-10/8GB	X4650A Not Offered by Sun X4651A X4652A	Sun Blade X6270 Server Module

Front view

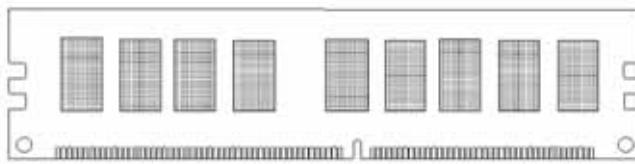


Notes

Tolerances on all dimensions except where otherwise indicated are ±.13 (.005).

All dimensions are expressed in millimeters [inches]

Back view



Side view

